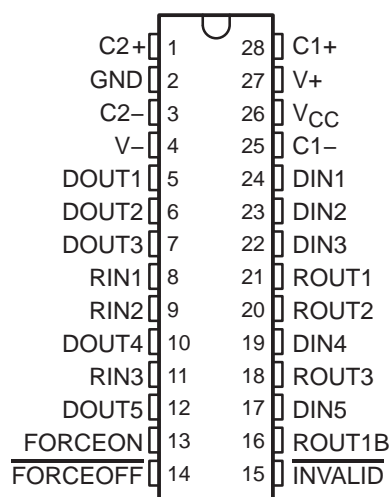


# 3-V TO 5.5-V MULTICHANNEL RS-232 LINE DRIVER/RECEIVER WITH $\pm 15$ -kV ESD (HBM) PROTECTION

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- **RS-232 Bus-Pin ESD Protection Exceeds  $\pm 15$  kV Using Human-Body Model (HBM)**
- **Meets or Exceeds the Requirements of TIA/EIA-232-F and ITU v.28 Standards**
- **Operates With 3-V to 5.5-V  $V_{CC}$  Supply**
- **Operates Up To 250 kbit/s**
- **Five Drivers and Three Receivers**
- **Low Standby Current . . . 1  $\mu$ A Typical**
- **External Capacitors . . .  $4 \times 0.1 \mu$ F**
- **Accepts 5-V Logic Input With 3.3-V Supply**
- **Always-Active Noninverting Receiver Output (ROUT1B)**
- **Alternative High-Speed Pin-Compatible Device (1 Mbit/s)**
  - SNx5C3238
- **Applications**
  - Battery-Powered Systems, PDAs, Notebooks, Subnotebooks, Laptops, Palmtop PCs, Hand-Held Equipment, Modems, and Printers

DB OR PW PACKAGE  
(TOP VIEW)

## description/ordering information

The MAX3238 consists of five line drivers, three line receivers, and a dual charge-pump circuit with  $\pm 15$ -kV ESD (HBM) protection pin to pin (serial-port connection pins, including GND). The device meets the requirements of TIA/EIA-232-F and provides the electrical interface between notebook and subnotebook computer applications. The charge pump and four small external capacitors allow operation from a single 3-V to 5.5-V supply. In addition, the device includes an always-active noninverting output (ROUT1B), which allows applications using the ring indicator to transmit data while the device is powered down. These devices operate at data signaling rates up to 250 kbit/s and a maximum of 30-V/ $\mu$ s driver output slew rate.

## ORDERING INFORMATION

| $T_A$         | PACKAGE†   |              | ORDERABLE PART NUMBER | TOP-SIDE MARKING |
|---------------|------------|--------------|-----------------------|------------------|
| –0°C to 70°C  | SSOP (DB)  | Tube of 50   | MAX3238CDB            | MAX3238C         |
|               |            | Reel of 2000 | MAX3238CDBR           |                  |
|               | TSSOP (PW) | Tube of 50   | MAX3238CPW            | MA3238C          |
|               |            | Reel of 2000 | MAX3238CPWR           |                  |
| –40°C to 85°C | SSOP (DB)  | Tube of 50   | MAX3238IDB            | MAX3238I         |
|               |            | Reel of 2000 | MAX3238IDBR           |                  |
|               | TSSOP (PW) | Tube of 50   | MAX3238IPW            | MB3238I          |
|               |            | Reel of 2000 | MAX3238IPWR           |                  |

† Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at [www.ti.com/sc/package](http://www.ti.com/sc/package).



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 **TEXAS  
INSTRUMENTS**

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**MAX3238****3-V TO 5.5-V MULTICHANNEL RS-232 LINE DRIVER/RECEIVER  
WITH ±15-kV ESD (HBM) PROTECTION**

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**description/ordering information (continued)**

Flexible control options for power management are featured when the serial port and driver inputs are inactive. The auto-powerdown plus feature functions when FORCEON is low and  $\overline{\text{FORCEOFF}}$  is high. During this mode of operation, if the device does not sense valid signal transitions on all receiver and driver inputs for approximately 30 s, the built-in charge pump and drivers are powered down, reducing the supply current to 1  $\mu\text{A}$ . By disconnecting the serial port or placing the peripheral drivers off, auto-powerdown plus occurs if there is no activity in the logic levels for the driver inputs. Auto-powerdown plus can be disabled when FORCEON and  $\overline{\text{FORCEOFF}}$  are high. With auto-powerdown plus enabled, the device activates automatically when a valid signal is applied to any receiver or driver input. INVALID is high (valid data) if any receiver input voltage is greater than 2.7 V or less than -2.7 V, or has been between -0.3 V and 0.3 V for less than 30  $\mu\text{s}$ . INVALID is low (invalid data) if all receiver input voltages are between -0.3 V and 0.3 V for more than 30  $\mu\text{s}$ . Refer to Figure 5 for receiver input levels.

**Function Tables****EACH DRIVER**

| INPUTS |         |                              |   | OUTPUT DOUT | DRIVER STATUS                                      |
|--------|---------|------------------------------|---|-------------|--|
| DIN    | FORCEON | $\overline{\text{FORCEOFF}}$ | TIME ELAPSED SINCE LAST RIN OR DIN TRANSITION |             |  |
| X      | X       | L                            | X   | Z           | Powered off  |
| L      | H       | H                            | X   | H           | Normal operation with auto-powerdown plus disabled |
| H      | H       | H                            | X   | L           |  |
| L      | L       | H                            | <30 s   | H           | Normal operation with auto-powerdown plus enabled  |
| H      | L       | H                            | <30 s   | L           |  |
| L      | L       | H                            | >30 s   | Z           | Powered off by auto-powerdown plus feature         |
| H      | L       | H                            | >30 s   | Z           |  |

H = high level, L = low level, X = irrelevant, Z = high impedance

**EACH RECEIVER**

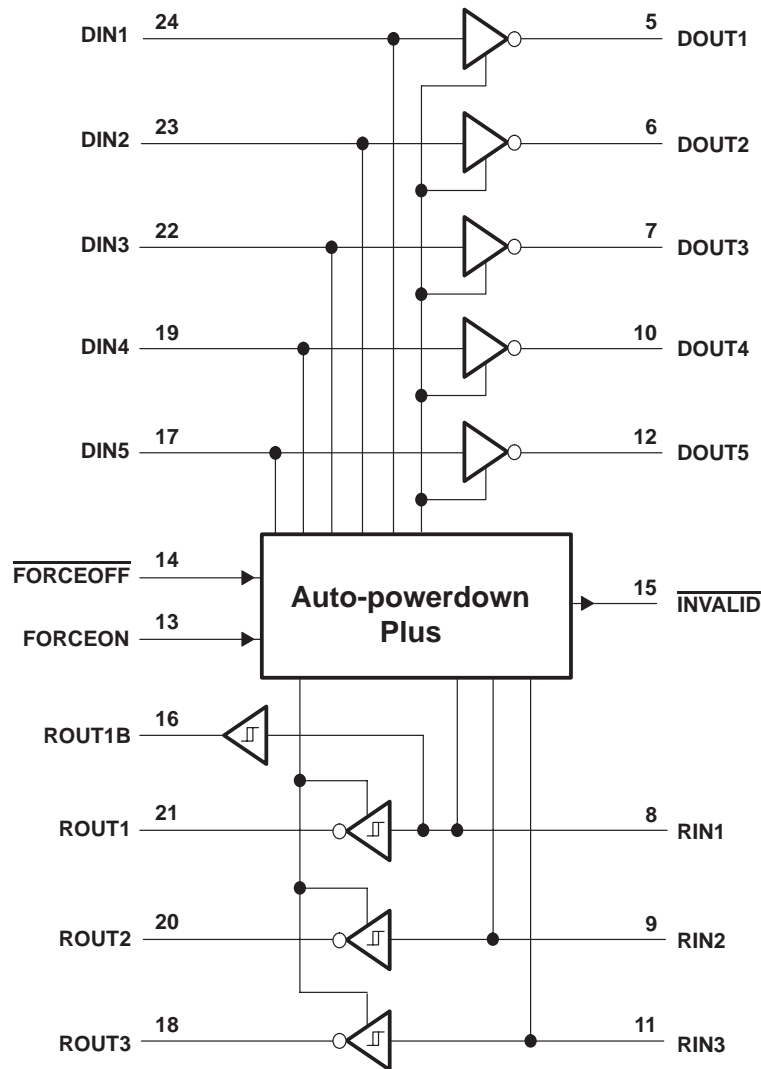
| INPUTS |           |                              |   | OUTPUTS |      | RECEIVER STATUS  |
|--------|-----------|------------------------------|---|---------|------|--|
| RIN1   | RIN2-RIN3 | $\overline{\text{FORCEOFF}}$ | TIME ELAPSED SINCE LAST RIN OR DIN TRANSITION | ROUT1B  | ROUT |  |
| L      | X         | L                            | X   | L       | Z    | Powered off while ROUT1B is active                         |
| H      | X         | L                            | X   | H       | Z    |  |
| L      | L         | H                            | <30 s   | L       | H    | Normal operation with auto-powerdown plus disabled/enabled |
| L      | H         | H                            | <30 s   | L       | L    |  |
| H      | L         | H                            | <30 s   | H       | H    |  |
| H      | H         | H                            | <30 s   | H       | L    |  |
| Open   | Open      | H                            | >30 s   | L       | H    |  |

H = high level, L = low level, X = irrelevant, Z = high impedance (off), Open = input disconnected or connected driver off



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logic diagram (positive logic)



# MAX3238

## 3-V TO 5.5-V MULTICHANNEL RS-232 LINE DRIVER/RECEIVER WITH ±15-kV ESD (HBM) PROTECTION

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### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

|   |                            |
|---|----------------------------|
| Supply voltage range, $V_{CC}$ (see Note 1)                                   | –0.3 V to 6 V              |
| Positive output supply voltage range, $V_+$ (see Note 1)                      | –0.3 V to 7 V              |
| Negative output supply voltage range, $V_-$ (see Note 1)                      | 0.3 V to –7 V              |
| Supply voltage difference, $V_+ - V_-$ (see Note 1)                           | 13 V                       |
| Input voltage range, $V_I$ : Driver ( $\overline{\text{FORCEOFF}}$ , FORCEON) | –0.3 V to 6 V              |
| Receiver  | –25 V to 25 V              |
| Output voltage range, $V_O$ : Driver  | –13.2 V to 13.2 V          |
| Receiver (INVALID)  | –0.3 V to $V_{CC} + 0.3$ V |
| Package thermal impedance, $\theta_{JA}$ (see Notes 2 and 3): DB package      | 62°C/W                     |
| PW package  | 62°C/W                     |
| Operating virtual junction temperature, $T_J$                                 | 150°C                      |
| Storage temperature range, $T_{stg}$  | –65°C to 150°C             |

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. All voltages are with respect to network GND.  
 2. Maximum power dissipation is a function of  $T_J(\text{max})$ ,  $\theta_{JA}$ , and  $T_A$ . The maximum allowable power dissipation at any allowable ambient temperature is  $P_D = (T_J(\text{max}) - T_A)/\theta_{JA}$ . Operating at the absolute maximum  $T_J$  of 150°C can affect reliability.  
 3. The package thermal impedance is calculated in accordance with JESD 51-7.

### recommended operating conditions (see Note 4 and Figure 6)

|                |   |   | MIN              | NOM | MAX | UNIT |    |
|----------------|---|---|------------------|-----|-----|------|----|
| Supply voltage |   | $V_{CC} = 3.3$ V                            | 3                | 3.3 | 3.6 | V    |    |
|                |   | $V_{CC} = 5$ V                              | 4.5              | 5   | 5.5 |      |    |
| $V_{IH}$       | Driver and control high-level input voltage | DIN, $\overline{\text{FORCEOFF}}$ , FORCEON | $V_{CC} = 3.3$ V |     | 2   | V    |    |
|                |   |   | $V_{CC} = 5$ V   |     | 2.4 |      |    |
| $V_{IL}$       | Driver and control low-level input voltage  | DIN, $\overline{\text{FORCEOFF}}$ , FORCEON |                  |     | 0.8 | V    |    |
| $V_I$          | Driver and control input voltage            | DIN, $\overline{\text{FORCEOFF}}$ , FORCEON | 0                |     |     | 5.5  | V  |
| $V_I$          | Receiver input voltage                      |   | –25              |     |     | 25   | V  |
| $T_A$          | Operating free-air temperature              | MAX3238C                                    | 0                |     |     | 70   | °C |
|                |   | MAX3238I                                    | –40              |     |     | 85   |    |

NOTE 4: Testing supply conditions are C1–C4 = 0.1  $\mu$ F at  $V_{CC} = 3.3$  V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at  $V_{CC} = 3.3$  V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F and C2–C4 = 0.33  $\mu$ F at  $V_{CC} = 5$  V  $\pm$  0.5 V.

### electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Note 4 and Figure 6)

| PARAMETER |   | TEST CONDITIONS                        | MIN  | TYP‡       | MAX     | UNIT    |         |
|-----------|---|--|--|------------|---------|---------|---------|
| $I_I$     | Input leakage current                       | $\overline{\text{FORCEOFF}}$ , FORCEON |  | $\pm$ 0.01 | $\pm$ 1 | $\mu$ A |         |
| $I_{CC}$  | Supply current ( $T_A = 25^\circ\text{C}$ ) | Auto-powerdown plus disabled           | No load, $\overline{\text{FORCEOFF}}$ and FORCEON at $V_{CC}$                                    |            | 0.5     | 2       | mA      |
|           |   | Powered off                            | No load, $\overline{\text{FORCEOFF}}$ at GND   |            | 1       | 10      |         |
|           |   | Auto-powerdown plus enabled            | No load, $\overline{\text{FORCEOFF}}$ at $V_{CC}$ , FORCEON at GND, All RIN are open or grounded |            | 1       | 10      | $\mu$ A |

‡ All typical values are at  $V_{CC} = 3.3$  V or  $V_{CC} = 5$  V, and  $T_A = 25^\circ\text{C}$ .

NOTE 4: Testing supply conditions are C1–C4 = 0.1  $\mu$ F at  $V_{CC} = 3.3$  V  $\pm$  0.15 V; C1–C4 = 0.22  $\mu$ F at  $V_{CC} = 3.3$  V  $\pm$  0.3 V; and C1 = 0.047  $\mu$ F and C2–C4 = 0.33  $\mu$ F at  $V_{CC} = 5$  V  $\pm$  0.5 V.



**MAX3238**  
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**DRIVER SECTION**

**electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Note 4 and Figure 6)**

| PARAMETER                                     | TEST CONDITIONS  | MIN  | TYP†  | MAX  | UNIT |
|---|--|--|-------|------|------|
| V <sub>OH</sub> High-level output voltage     | All DOUT at R <sub>L</sub> = 3 kΩ to GND   | 5  | 5.4   |      | V    |
| V <sub>OL</sub> Low-level output voltage      | All DOUT at R <sub>L</sub> = 3 kΩ to GND   | -5   | -5.4  |      | V    |
| I <sub>IH</sub> High-level input current      | V <sub>I</sub> = V <sub>CC</sub>   |  | ±0.01 | ±1   | μA   |
| I <sub>IL</sub> Low-level input current       | V <sub>I</sub> at GND  |  | ±0.01 | ±1   | μA   |
| I <sub>OS</sub> Short-circuit output current‡ | V <sub>CC</sub> = 3.6 V, V <sub>O</sub> = 0 V                                      |  | ±35   | ±60  | mA   |
|   | V <sub>CC</sub> = 5.5 V, V <sub>O</sub> = 0 V                                      |  | ±40   | ±100 |      |
| r <sub>o</sub> Output resistance              | V <sub>CC</sub> , V <sub>+</sub> , and V <sub>-</sub> = 0 V, V <sub>O</sub> = ±2 V | 300  | 10M   |      | Ω    |
| I <sub>off</sub> Output leakage current       | FORCEOFF = GND   | V <sub>O</sub> = ±12 V, V <sub>CC</sub> = 3 V to 3.6 V   |       | ±25  | μA   |
|   |  | V <sub>O</sub> = ±10 V, V <sub>CC</sub> = 4.5 V to 5.5 V |       | ±25  |      |

† All typical values are at V<sub>CC</sub> = 3.3 V or V<sub>CC</sub> = 5 V, and T<sub>A</sub> = 25°C.

‡ Short-circuit durations should be controlled to prevent exceeding the device absolute power-dissipation ratings, and not more than one output should be shorted at a time.

NOTE 4: Testing supply conditions are C1–C4 = 0.1 μF at V<sub>CC</sub> = 3.3 V ± 0.15 V; C1–C4 = 0.22 μF at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047 μF and C2–C4 = 0.33 μF at V<sub>CC</sub> = 5 V ± 0.5 V.

**switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Note 4 and Figure 6)**

| PARAMETER  | TEST CONDITIONS   | MIN                                | TYP† | MAX | UNIT   |
|--|---|------------------------------------|------|-----|--------|
| Maximum data rate                                  | C <sub>L</sub> = 1000 pF, R <sub>L</sub> = 3 kΩ, One DOUT switching, See Figure 1 | 150                                | 250  |     | kbit/s |
| t <sub>sk(p)</sub> Pulse skew§                     | C <sub>L</sub> = 150 pF to 2500 pF, R <sub>L</sub> = 3 kΩ to 7 kΩ, See Figure 2   |                                    | 100  |     | ns     |
| SR(tr) Slew rate, transition region (see Figure 1) | V <sub>CC</sub> = 3.3 V, R <sub>L</sub> = 3 kΩ to 7 kΩ                            | C <sub>L</sub> = 150 pF to 1000 pF | 6    | 30  | V/μs   |
|  |   | C <sub>L</sub> = 150 pF to 2500 pF | 4    | 30  |        |

† All typical values are at V<sub>CC</sub> = 3.3 V or V<sub>CC</sub> = 5 V, and T<sub>A</sub> = 25°C.

§ Pulse skew is defined as |t<sub>PLH</sub> – t<sub>PHL</sub>| of each channel of the same device.

NOTE 4: Testing supply conditions are C1–C4 = 0.1 μF at V<sub>CC</sub> = 3.3 V ± 0.15 V; C1–C4 = 0.22 μF at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047 μF and C2–C4 = 0.33 μF at V<sub>CC</sub> = 5 V ± 0.5 V.

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**RECEIVER SECTION****electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Note 4 and Figure 6)**

| PARAMETER        |   | TEST CONDITIONS                | MIN                    | TYP†                   | MAX | UNIT |
|------------------|---|--------------------------------|------------------------|------------------------|-----|------|
| V <sub>OH</sub>  | High-level output voltage                               | I <sub>OH</sub> = -1 mA        | V <sub>CC</sub> -0.6 V | V <sub>CC</sub> -0.1 V |     | V    |
| V <sub>OL</sub>  | Low-level output voltage                                | I <sub>OL</sub> = 1.6 mA       |                        |                        | 0.4 | V    |
| V <sub>IT+</sub> | Positive-going input threshold voltage                  | V <sub>CC</sub> = 3.3 V        |                        | 1.5                    | 2.4 | V    |
|                  |   | V <sub>CC</sub> = 5 V          |                        | 1.8                    | 2.4 |      |
| V <sub>IT-</sub> | Negative-going input threshold voltage                  | V <sub>CC</sub> = 3.3 V        | 0.6                    | 1.2                    |     | V    |
|                  |   | V <sub>CC</sub> = 5 V          | 0.8                    | 1.5                    |     |      |
| V <sub>hys</sub> | Input hysteresis (V <sub>IT+</sub> - V <sub>IT-</sub> ) |                                |                        | 0.3                    |     | V    |
| I <sub>off</sub> | Output leakage current (except ROUT1B)                  | FORCEOFF = 0 V                 |                        | ±0.05                  | ±10 | μA   |
| r <sub>i</sub>   | Input resistance  | V <sub>I</sub> = ±3 V to ±25 V | 3                      | 5                      | 7   | kΩ   |

† All typical values are at V<sub>CC</sub> = 3.3 V or V<sub>CC</sub> = 5 V, and T<sub>A</sub> = 25°C.NOTE 4: Testing supply conditions are C1-C4 = 0.1 μF at V<sub>CC</sub> = 3.3 V ± 0.15 V; C1-C4 = 0.22 μF at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047 μF and C2-C4 = 0.33 μF at V<sub>CC</sub> = 5 V ± 0.5 V.**switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Note 4)**

| PARAMETER          |   | TEST CONDITIONS  | MIN | TYP† | MAX | UNIT |
|--------------------|---|--|-----|------|-----|------|
| t <sub>PLH</sub>   | Propagation delay time, low- to high-level output | C <sub>L</sub> = 150 pF, See Figure 3                        |     | 150  |     | ns   |
| t <sub>PHL</sub>   | Propagation delay time, high- to low-level output |  |     | 150  |     | ns   |
| t <sub>en</sub>    | Output enable time                                | C <sub>L</sub> = 150 pF, R <sub>L</sub> = 3 kΩ, See Figure 4 |     | 200  |     | ns   |
| t <sub>dis</sub>   | Output disable time                               |  |     | 200  |     | ns   |
| t <sub>sk(p)</sub> | Pulse skew‡                                       | See Figure 3   |     | 50   |     | ns   |

† All typical values are at V<sub>CC</sub> = 3.3 V or V<sub>CC</sub> = 5 V, and T<sub>A</sub> = 25°C.‡ Pulse skew is defined as |t<sub>PLH</sub> - t<sub>PHL</sub>| of each channel of the same device.NOTE 4: Testing supply conditions are C1-C4 = 0.1 μF at V<sub>CC</sub> = 3.3 V ± 0.15 V; C1-C4 = 0.22 μF at V<sub>CC</sub> = 3.3 V ± 0.3 V; and C1 = 0.047 μF and C2-C4 = 0.33 μF at V<sub>CC</sub> = 5 V ± 0.5 V.

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**AUTO-POWERDOWN PLUS SECTION**

**electrical characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 5)**

| PARAMETER               |  | TEST CONDITIONS   | MIN                  | TYP† | MAX | UNIT |
|-------------------------|--|---|----------------------|------|-----|------|
| V <sub>T+(valid)</sub>  | Receiver input threshold for INVALID high-level output voltage | FORCEON = GND, FORCEOFF = V <sub>CC</sub>                           |                      |      | 2.7 | V    |
| V <sub>T-(valid)</sub>  | Receiver input threshold for INVALID high-level output voltage | FORCEON = GND, FORCEOFF = V <sub>CC</sub>                           | -2.7                 |      |     | V    |
| V <sub>T(invalid)</sub> | Receiver input threshold for INVALID low-level output voltage  | FORCEON = GND, FORCEOFF = V <sub>CC</sub>                           | -0.3                 |      | 0.3 | V    |
| V <sub>OH</sub>         | INVALID high-level output voltage                              | I <sub>OH</sub> = -1 mA, FORCEON = GND, FORCEOFF = V <sub>CC</sub>  | V <sub>CC</sub> -0.6 |      |     | V    |
| V <sub>OL</sub>         | INVALID low-level output voltage                               | I <sub>OL</sub> = 1.6 mA, FORCEON = GND, FORCEOFF = V <sub>CC</sub> |                      |      | 0.4 | V    |

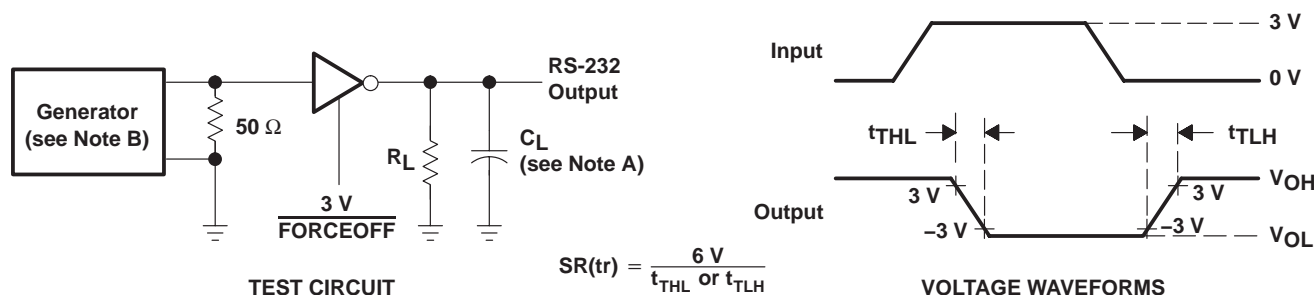
† All typical values are at V<sub>CC</sub> = 3.3 V or V<sub>CC</sub> = 5 V, and T<sub>A</sub> = 25°C.

**switching characteristics over recommended ranges of supply voltage and operating free-air temperature (unless otherwise noted) (see Figure 5)**

| PARAMETER            |   | MIN | TYP† | MAX | UNIT |
|----------------------|---|-----|------|-----|------|
| t <sub>valid</sub>   | Propagation delay time, low- to high-level output |     | 0.1  |     | μs   |
| t <sub>invalid</sub> | Propagation delay time, high- to low-level output |     | 50   |     | μs   |
| t <sub>en</sub>      | Supply enable time                                |     | 25   |     | μs   |
| t <sub>dis</sub>     | Receiver or driver edge to auto-powerdown plus    | 15  | 30   | 60  | s    |

† All typical values are at V<sub>CC</sub> = 3.3 V or V<sub>CC</sub> = 5 V, and T<sub>A</sub> = 25°C.

**PARAMETER MEASUREMENT INFORMATION**



NOTES: A. C<sub>L</sub> includes probe and jig capacitance.

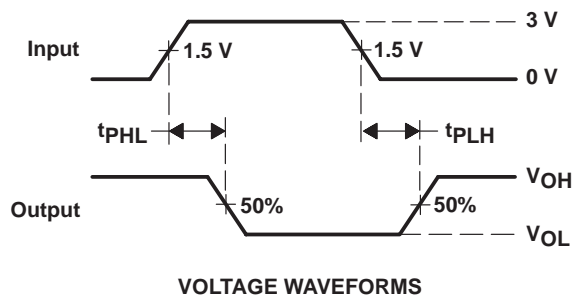
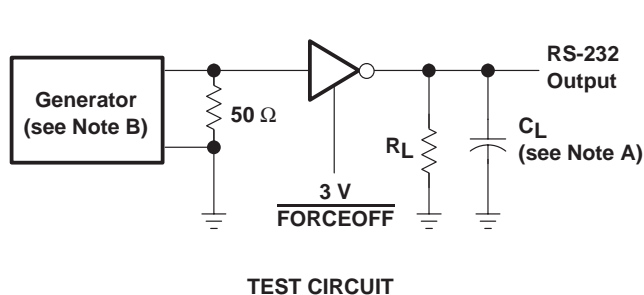
B. The pulse generator has the following characteristics: PRR = 250 kbit/s, Z<sub>O</sub> = 50 Ω, 50% duty cycle, t<sub>r</sub> ≤ 10 ns, t<sub>f</sub> ≤ 10 ns.

**Figure 1. Driver Slew Rate**

**MAX3238**  
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**WITH ±15-kV ESD (HBM) PROTECTION**

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**PARAMETER MEASUREMENT INFORMATION**

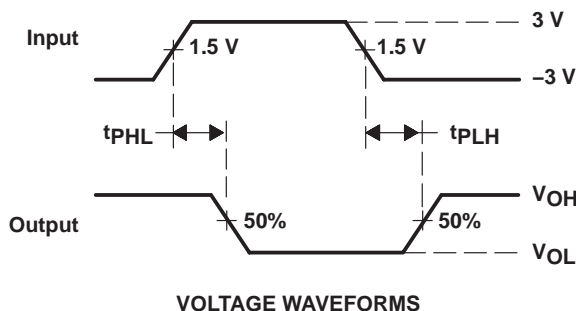
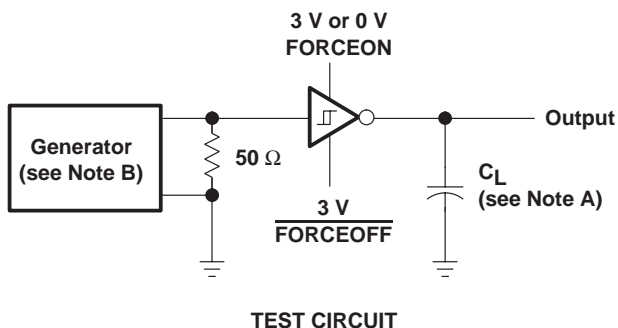


**TEST CIRCUIT**

**VOLTAGE WAVEFORMS**

NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. The pulse generator has the following characteristics: PRR = 250 kbit/s,  $Z_O = 50 \Omega$ , 50% duty cycle,  $t_r \leq 10$  ns,  $t_f \leq 10$  ns.

**Figure 2. Driver Pulse Skew**

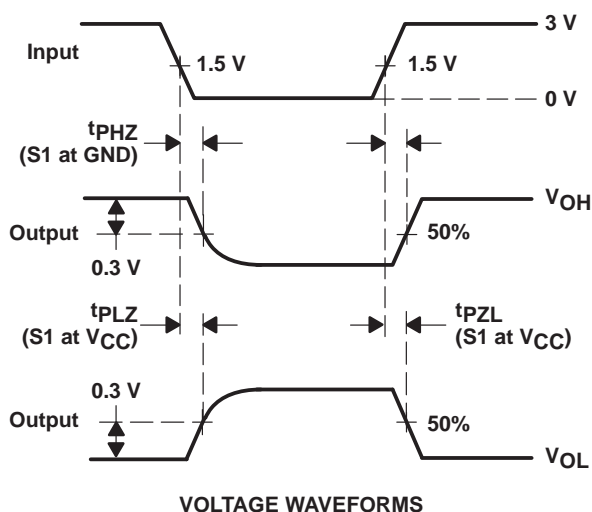
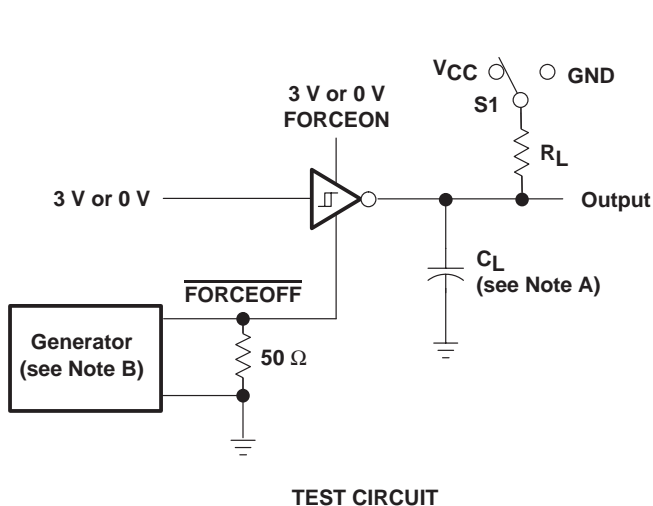


**TEST CIRCUIT**

**VOLTAGE WAVEFORMS**

NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. The pulse generator has the following characteristics:  $Z_O = 50 \Omega$ , 50% duty cycle,  $t_r \leq 10$  ns,  $t_f \leq 10$  ns.

**Figure 3. Receiver Propagation Delay Times**



**TEST CIRCUIT**

**VOLTAGE WAVEFORMS**

NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. The pulse generator has the following characteristics:  $Z_O = 50 \Omega$ , 50% duty cycle,  $t_r \leq 10$  ns,  $t_f \leq 10$  ns.  
 C.  $t_{PLZ}$  and  $t_{PHZ}$  are the same as  $t_{dis}$ .  
 D.  $t_{PZL}$  and  $t_{PZH}$  are the same as  $t_{en}$ .

**Figure 4. Receiver Enable and Disable Times**

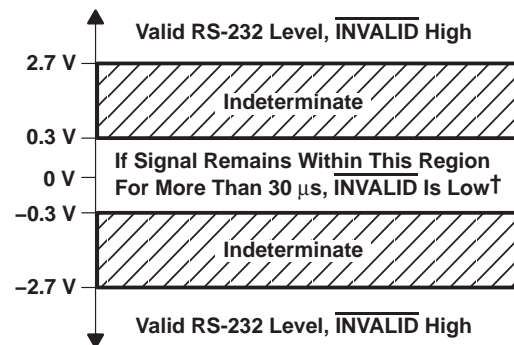
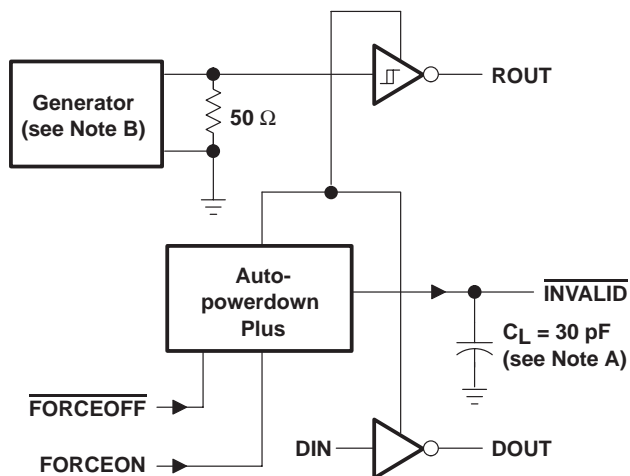




**MAX3238**  
**3-V TO 5.5-V MULTICHANNEL RS-232 LINE DRIVER/RECEIVER**  
**WITH  $\pm 15$ -kV ESD (HBM) PROTECTION**

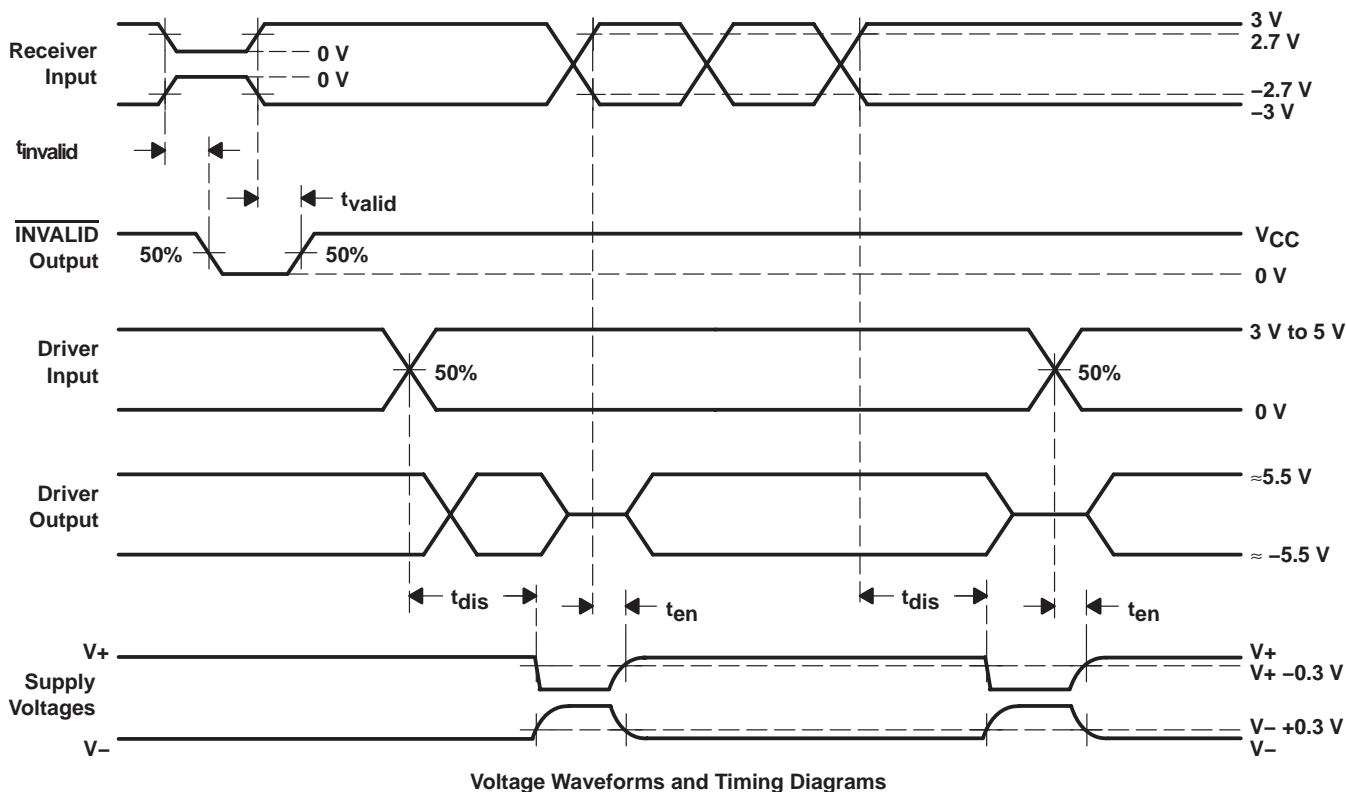
SLLS349J – JUNE 1999 – REVISED MARCH 2004

**PARAMETER MEASUREMENT INFORMATION**



**TEST CIRCUIT**

- NOTES: A.  $C_L$  includes probe and jig capacitance.  
 B. The pulse generator has the following characteristics: PRR = 5 kbit/s,  $Z_O = 50 \Omega$ , 50% duty cycle,  $t_r \leq 10 \text{ ns}$ ,  $t_f \leq 10 \text{ ns}$ .

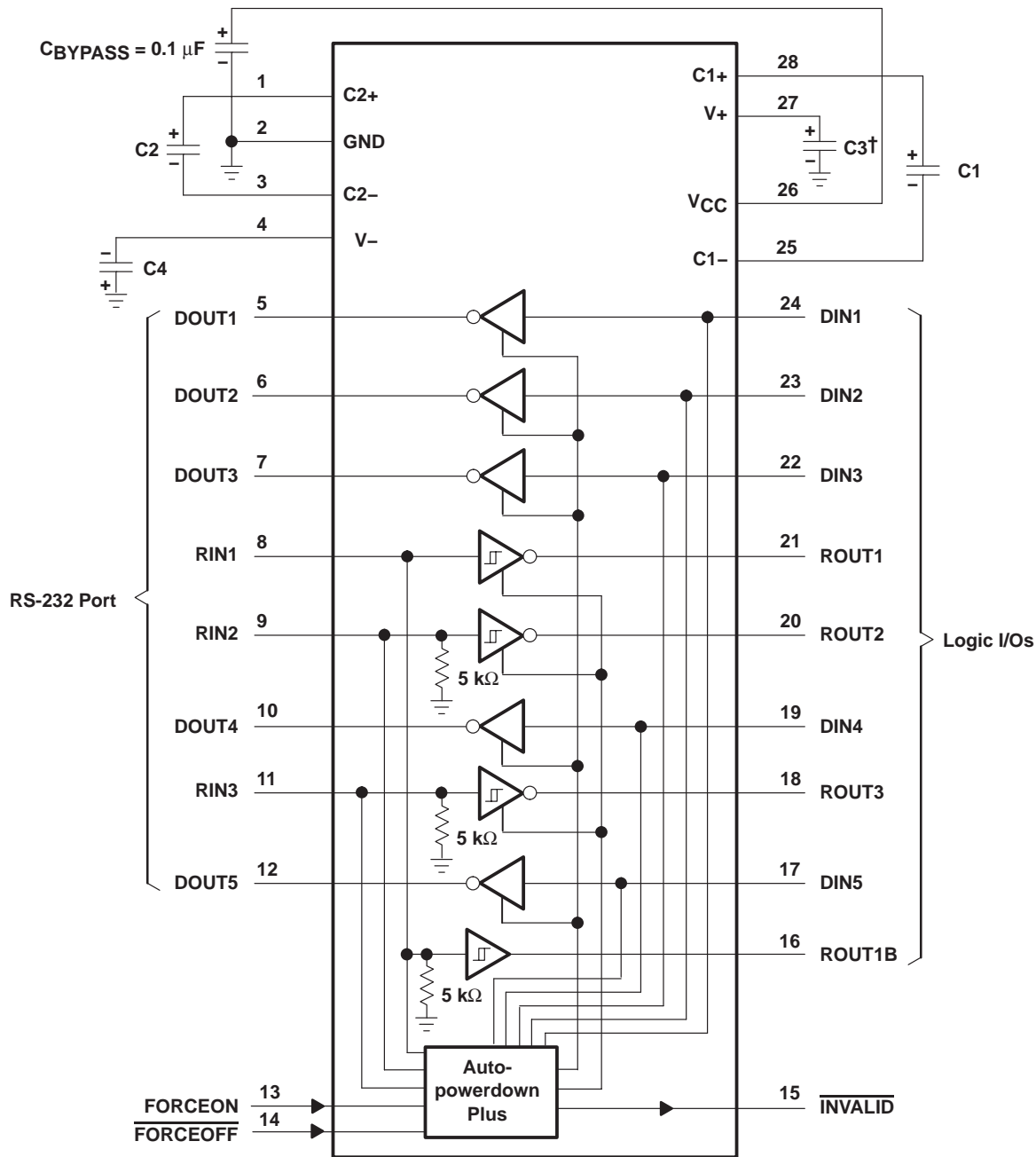


**Figure 5.  $\overline{\text{INVALID}}$  Propagation-Delay Times and Supply-Enabling Time**

**MAX3238**  
**3-V TO 5.5-V MULTICHANNEL RS-232 LINE DRIVER/RECEIVER**  
**WITH ±15-kV ESD (HBM) PROTECTION**

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**APPLICATION INFORMATION**



**V<sub>CC</sub> vs CAPACITOR VALUES**

| V <sub>CC</sub> | C1       | C2, C3, and C4 |
|-----------------|----------|----------------|
| 3.3 V ± 0.15 V  | 0.1 μF   | 0.1 μF         |
| 3.3 V ± 0.3 V   | 0.22 μF  | 0.22 μF        |
| 5 V ± 0.5 V     | 0.047 μF | 0.33 μF        |
| 3 V to 5.5 V    | 0.22 μF  | 1 μF           |

- † C3 can be connected to V<sub>CC</sub> or GND.  
 NOTES: A. Resistor values shown are nominal.  
 B. Nonpolarized ceramic capacitors are acceptable. If polarized tantalum or electrolytic capacitors are used, they should be connected as shown.

**Figure 6. Typical Operating Circuit and Capacitor Values**



DB (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-150

PW (R-PDSO-G\*\*)

PLASTIC SMALL-OUTLINE PACKAGE

14 PINS SHOWN



4040064/F 01/97

- NOTES: A. All linear dimensions are in millimeters.  
 B. This drawing is subject to change without notice.  
 C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.  
 D. Falls within JEDEC MO-153

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